



<b>ENVIRONMENTAL AND PACKAGE TESTING DATA FOR PowerPAK® 1212-8</b>					
<b>STRESS</b>	<b>SAMPLE SIZE</b>	<b>DEVICE HR./CYC</b>	<b>CONDITION</b>	<b>TOTAL FAILS</b>	<b>FAIL PERCENTAGE</b>
BOND INT	440	220 000	200 °C + N2	0	0
HAST	5880	580 046	130 °C, 85 % RH	0	0
Pressure Pot	6048	580 608	121°, 15 PSIG	0	0
Solder DUNK	379	1137	260 °C, 10 s	0	0
Solderability	45	360	883 M2003	0	0
Temp. Cycle	7156	6 063 580	-55 °C to 150 °C	0	0